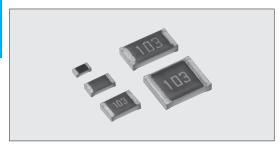
THICK FILM (ANTI SURGE)



SG73S Endured Surge Voltage Flat Chip Resistors



Coating color: Black (1E)

Green (1J, 2A, 2B, 2E, 2E1)

■Features

- Superior to RK73 series chip resistors in surge withstanding voltage and high power.
- Resistance tolerance is available from $\pm 0.5\%$.
- Suitable for both reflow and flow solderings.
- Products with lead free termination meet EU-RoHS requirements. EU-RoHS regulation is not intended for Pb-glass contained in electrode, resistor element and glass.
- AEC-Q200 Tested.

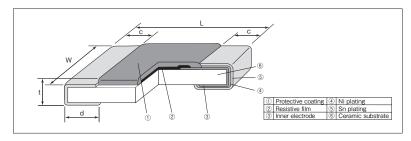
Applications

- E.C.U.
- Circuits to catch inductive lighting surge.

■Reference Standards

IEC 60115-8 JIS C 5201-8 EIAJ RC-2134C

■Construction

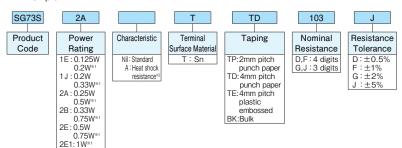


■Dimensions

Туре		Weight(g)				
(Inch Size Code)	L	W	С	d	t	(1000pcs)
1E (0402)	1.0+0.1	0.5±0.05	0.15±0.1	$0.25^{+0.05}_{-0.1}$	0.35±0.05	0.68
1J (0603)	1.6±0.2	0.8±0.1	0.3±0.1	0.3±0.1	0.45±0.1	2.14
1J AT (0603)	1.0±0.2		0.35±0.15	0.5±0.2	0.45±0.1	
2A (0805)	2.0±0.2	1.25±0.1	0.3+0.2	$0.3^{+0.2}_{-0.1}$	0.5±0.1	4.54
2A AT (0805)	2.0±0.2		0.45±0.25	0.6±0.2	0.55±0.1	
2B (1206)		1.6±0.2	$0.4^{+0.2}_{-0.1}$	0.4 ^{+0.2}		0.14
2B AT (1206)	20+00		0.55±0.35	0.8±0.2	0.6+0.1	9.14
2E (1210)	3.2±0.2	2.6±0.2	0.4+0.2	0.4+0.2	0.6±0.1	155
2E1 (1210)						15.5

■Type Designation

Example



 $\ensuremath{\mbox{\%}}\xspace 2\ \mbox{1J, 2A, and 2B}$ are available for Heat shock resistance.

No resistance marking.

Contact us when you have control request for environmental hazardous material other than the substance specified by EU-RoHS.

For further information on taping, please refer to APPENDIX C on the back pages.

Ratings

_		Pated	Rated Rated	T.C.R.	Resistance Range (Ω)		May	May				
Type Power Rating		ting Ambient	Terminal Part Temp.	(×10 ⁻⁶ / K)	D:±0.5%	F:±1%	G:±2% J:±5%	Max. Working Voltage	king Overload	Packaging & Q' ty/Reel (pcs)		
	Temp.	rait rellip.	K)	E24 · E96	E24 · E96	E24	Voitage	Vollage	TP	TD	TE	
1E	0.125W	70°C	125℃	±200	10~1M 1~1M	4 . 414	1. 1014	75V	100V	10,000		
'E	0.2W*1	70°C	105℃			1~10M	750	1000	10,000	_	_	
	0.2W	70℃	135℃	±100	510~576k	510~576k	510~560k	150V	200V	10,000*5	5,000	_
				±100*3	10~499 590k~1M	1~499 590k~1M	1~470 620k~10M					
1J	1J			±100	510~576k		510~560k					
0.33W*1	70℃	125℃	±100*3	10~499 590k~1M	1~499 590k~1M	1~470 620k~10M						
0.4	0.25W	70°C	125℃	±200	10~1M 1~1M 1~10M	4 414	4 4014	400)/	600V	40.000	F 000	4.000*5
2A	0.5W*1	70°C	100℃			400V	(800V)**4	10,000**5	5,000	4,000**5		
2B	0.33W	70°C	125℃	±200	10~1M	1~1M	1~10M	200V	400V	_	5,000	4,000**5
28	0.75W*1	70°C	105℃									
2E	0.5W	70°C	125℃	±200	10~1M	1~1M	4 4014	0001	400V	_	5,000	4,000*5
2E	0.75W*1	70°C	110℃				1~10M	200V				
2E1	1.0W*1	70°C	95℃	±200	10~1M	1~1M	1~10M	200V	400V	_	5,000	4,000*5

Operating Temperature Range: −55°C~+155°C

 $Rated\ voltage = \sqrt{Power\ Rating \times Resistance\ value}\ or\ Max.\ working\ voltage,\ whichever\ is\ lower.$

*1 If you use at the rated power, please keep the condition that the terminal of the resistor is below the rated terminal part temperature. Please refer to the derating curves based on the terminal temperature of right side on the next page.

3 Cold T.C.R. (−55°C \sim +25°C) is \pm 150×10⁻⁶/K

%4 Applies when power rating is 0.4W or lower.

*5 Standard packaging : TD(4mm pitch punch paper)

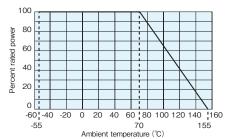
If any questions arise whether to use the "Rated Ambient Temperature" or the "Rated Terminal Part Temperature" in your usage conditions, please give priority to the "Rated Terminal Part Temperature".

For more details, please refer to "Introduction of the derating curves based on the terminal part temperature" on the beginning of our catalog.



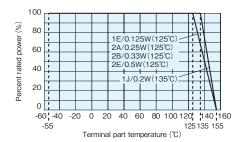
Derating Curve

Ambient temperature

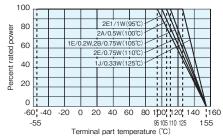


For resistors operated at an ambient temperature of $70^\circ\!\mathrm{C}$ or higher, the power shall be derated in accordance with the above derating

Terminal part temperature

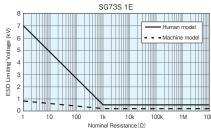


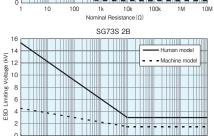
Terminal part temperature



When the terminal part temperature of the resistor exceeds the rated terminal part temperature shown above, the power shall be derated according to the derating curve. If you want to use at the rated power of %1 or %4, please use the derating curves based on the terminal part temperature of right side. %1Please refer to "Introduction of the derating curves based on the terminal part temperature" on the beginning of our catalog before use.

■ESD Limiting Voltage

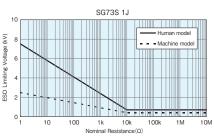


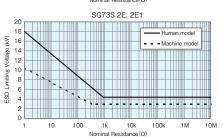


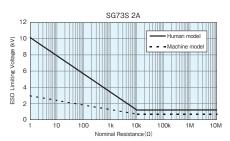
10k

istance(0)

100k 1M

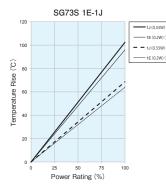


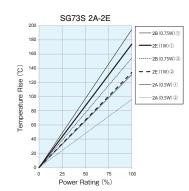




■Temperature Rise

10 100 1k





Regarding the temperature rise, the value of the temperature varies per conditions and board for use since the temperature is measured under our measuring conditions.

Room temperature: 25°C PCB: FR-4t = 1.6mm

Performance

Test Items	Performance Requirements ΔR±	(%+0.1Ω)	Test Methods		
	Limit	Typical	Test Methods		
Resistance	Within specified tolerance	_	25℃		
T.C.R.	Within specified T.C.R.	_	+25°C/-55°C and +25°C/+125°C		
Overload (Short time)	2	0.5	Rated voltage × 2.5 for 5s (2A: 0.4W, 0.5W, 2B: 0.75W, 2E: 0.75W, 2E1: 1W Rated voltage × 2 for 5s)		
Resistance to soldering heat	1	0.75	260°C±5°C, 10s±1s		
Rapid change of temperature	0.5: Characteristic [Nil] (Standard) 1: Characteristic [A] (Heat shock resistance)	0.3: Characteristic [Nil] (Standard) 0.5: Characteristic [A] (Heat shock resistance)	Characteristic [Nil] (Standard): -55°C (30min.)/+125°C (30min.)100 cycles Characteristic [A] (Heat shock resistance): -55°C (30min.)/+125°C (30min.)1000 cycles		
Moisture resistance	3	0.75	40°C±2°C, 90%∼95%RH, 1000h 1.5h ON/0.5h OFF cycle		
Endurance at 70°C or rated terminal part temperature	3	0.75	$70^{\circ}\text{C}\pm2^{\circ}\text{C}$ or rated terminal part temperature $\pm2^{\circ}\text{C}$ 1000h 1.5h ON/0.5h OFF cycle		
High temperature exposure	1	0.3	+155°C, 1000h		

■Precautions for Use

• The substrate of chip resistors is alumina. Cracks may occur at the connection of solder (solder fillet portion) due to the difference of the coefficient of thermal expansion from a mounting board when heat stress like heat cycle, etc. are repeatedly given to them. Care should be taken to the occurrence of the cracks when the change in ambient temperature or ON/OFF of load is repeated. The occurrence of the crack by heat stress may be influenced by the size of a pad, solder volume, heat radiation of mounting board etc., so please pay careful attention to designing when a big change in ambient temperature and conditions for use like ON/OFF of load can be assumed.